Version No.:

02

SPECIFICATIONS

PRODUCT : LCD MODULE

MODEL NO. : S69509-DD025MB

CUSTOMER NO.:

M1-1381H

	SUCCESS	CUSTOMER	
PREPARED	CHECKED	APPROVED	APPROVED
СҮК	ZC	НЈВ	

□APPROVAL FOR SPECIFICATIONS ONLY

■APPROVAL FOR SPECIFICATIONS AND SAMPLE

深圳市宇顺电子股份有限公司

SUCCESS ELECTRONICS LTD

Address:Block 21-23, Changxing industrial Estate μ, Changzhen village, Gongming town, ,Shenzhen, China Tel: +86-755-27179653-2790

[&]quot;Not to use the substances and their applications of SUCCESS Management Standard for Environment-related Substances to be Controlled"



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RECORDS OF REVISION

DATE	REVISED NO.	REVISED DESCRIPTIONS	PREPARED	CHECKED	APPROVED
2015-11-09	01	New release	Caoyunkai	Zhangchao	Hujinbo
2017-01-06	02	Change BL structure	ZX	IJQ	НЈВ



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1. GENERAL SPECIFICATIONS

1-1.DESCRIPTION:

The S69509-DD025MB is a dot matrix mono Liquid Crystal Display Module(LCM). This specification covers the delivery requirements for the liquid crystal display delivered by SUCCESS ELECTRONIC to Customer.

1-2. FEATURES

(1) Display Type: DSTN, Negative, Transmissive, 6O'clock

(2) Driving Method: VDD=3.3V, 1/65 duty, 1/9 bias

(3) Built-in controller: ST7565R

(4) With White Backlight

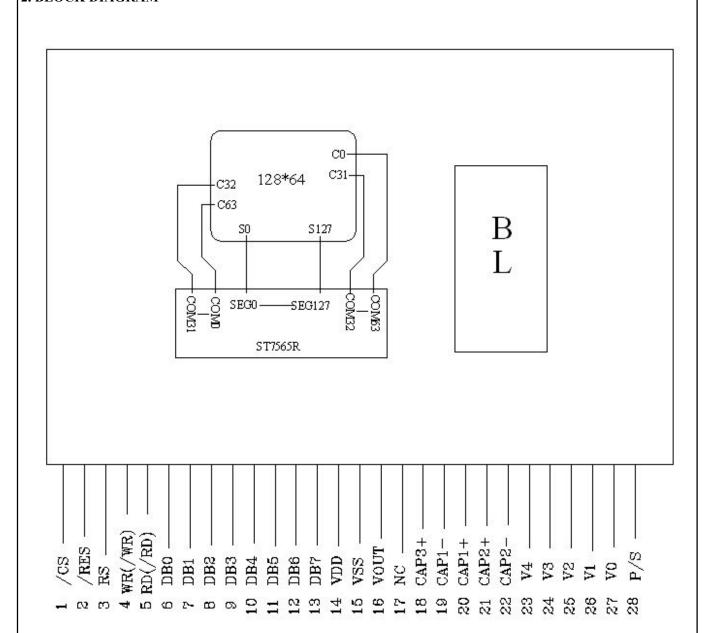
1-3.GENERAL SPECIFICATION

ITEM	SPECIFICATIONS	UNIT
DISP.CONSTRUCTION	128*64 Dots	
OUTLINE DIMEMSIONS	67.15(W)*48.15(H)*5.30(T)(Not Included FPC)	mm
VIEWING AREA	60.00(W) x31.40(H)	mm
ACTIVE AREA	57.57(W) x 28.77(H)	mm
DOT SIZE	0.42(W) x 0.42(H)	mm
DOT PITCH	0.45(W) x 0.45(H)	mm
ASSY.TYPE	COG+FPC+BL	
INTERFACE	6800/SPI	
BACKLIGHT	White	

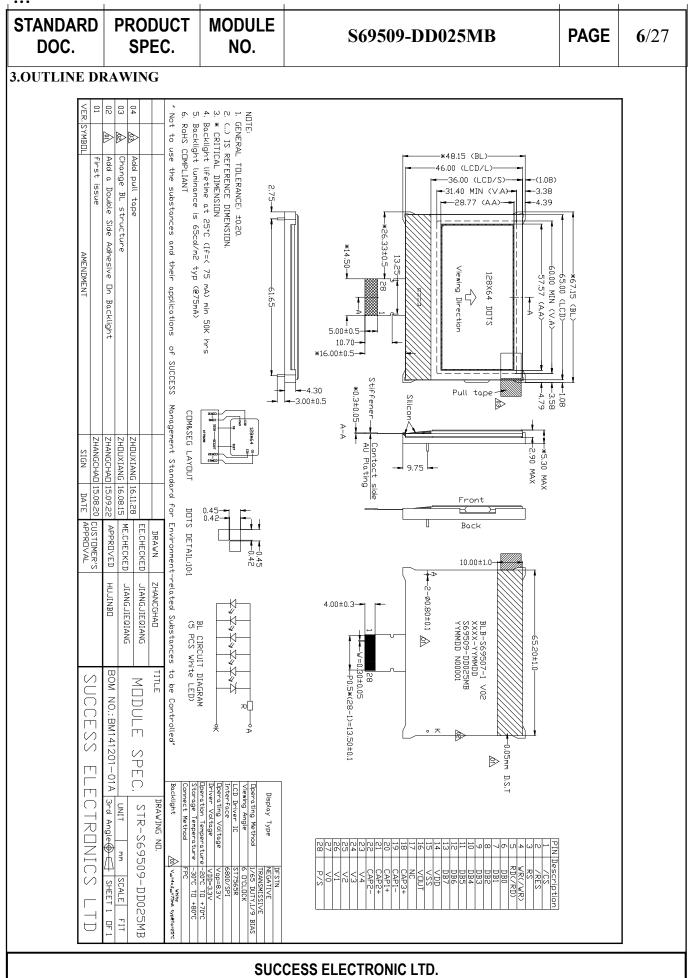
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2. BLOCK DIAGRAM









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NTERFACE	ASSIGNMENT						
1	Chip select input	pin		/CS			
2	Chip reset input p	oin		/RES	S		
3	Chip data/instruc	nip data/instruction selection pin					
4	When $R/W = $ "	ead/Write signal select When R/W = "H": Read When R/W = "L": Write					
5	Enable signal, sta	rt data read/wr	ite	RD(/RD)		
6~13	8 bit data Bus Lir	ne		DB0	~DB7		
14	Logic power supp	oly, +3.3V		VDI)		
15	Ground, 0V						
16	DC/DC voltage converter. Connect a capacitor between thisterminal and VSS or VDD						
17	NOT CONNECT						
18	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1-terminal						
19	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal						
20	DC/DC voltage of terminal	converter. Con	nect a capacitor between this terminal and the CAP1	CAF	·1+		
21	DC/DC voltage CAP2-terminal	converter. Co	onnect a capacitor between this terminal and the	CAF	·2+		
22	DC/DC voltage CAP2+terminal	converter. Co	onnect a capacitor between this terminal and the	e CAP2-			
23				V4			
24	LCD driver sur	ply voltages.7	Thevoltage determined by LCD cell is Impedance	eV3			
25	1		or an operation amplifier for application. Voltage				
26	-		ship: $V0 \ge V1 \ge V2 \ge V3 \ge V4 \ge VSS$	V1			
27				V0			
28	This pin configur	es the interface	to parallel mode or serial mode.	P/S			

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APPLICATIO	ON CIRCUIT							
	MPU					LC	М	
					PIN	Desc	cription	
		16	CS		1	/(CS	
		15	RES		- 2	//	RES	
		4	RS		- 3	RS	5	
					4	WR	(/WR)	
					- 5		(/RD)	
					6		30	
					7	Df		
					- 8		32	
					9		33	
					10		34	
		7	P1.0		11		35 36	
		/ 8	P1.1		13		36 37	\perp
		2	VDD		14) DD	_
		1	VSS		15		55 55	_
		1			16		DUT	
				1UF/16V	17	N		\dashv
				1UF/16V	18		AP3+	

Remark: Applied to 4-Line SPI.

1UF/16V

____ 1UF/16V

1UF/16V

1UF/16V

1UF/16V

1UF/16V

CAP1+

CAP2+

CAP2-

V4

V3

V2

V1

VO

P/S

20 21

22

23

24

25

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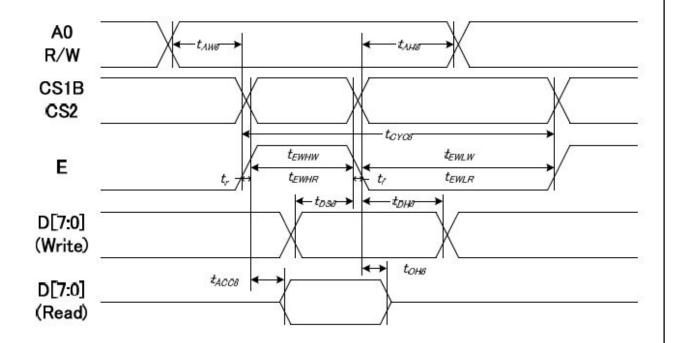
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6. TIMING CHARACTERISTICS

6-1 For the 6800 series MPU(Default Mode)

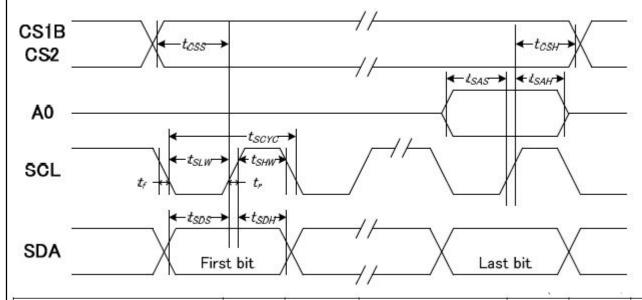


Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	40	tAW6		0	-	
Address hold time	A0	tAH6		0	_	
System cycle time		tCYC6		240	S 	
Enable L pulse width (WRITE)		tEWLW		80	S 	
Enable H pulse width (WRITE)	E	tEWHW		80	S 	
Enable L pulse width (READ)		tEWLR		80	(ns
Enable H pulse width (READ)		tEWHR		140		
Write data setup time		tDS6		40	1-	
Write data hold time	D(7:01	tDH6		10	<u> </u>	
Read data access time	D[7:0]	tACC6	CL = 100 pF	-	70	
Read data output disable time		tOH6	CL = 100 pF	5	50	



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6-2 For 4-Line Serial Interface

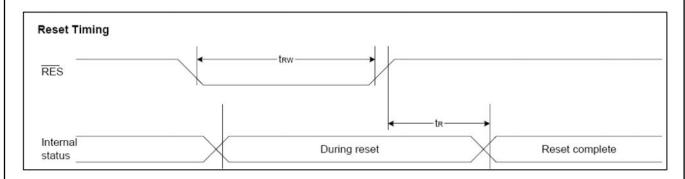


Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		50	s 	
SCLK "H" pulse width	SCLK	tSHW		25	5	
SCLK "L" pulse width		tSLW		25	-]
Address setup time	40	tSAS		20	-	
Address hold time	A0	tSAH		10	_	ns
Data setup time	CD.A	tSDS		20	_	
Data hold time	SDA	tSDH		10		
CS-SCLK time	CS1B	tCSS		20	_	
CS-SCLK time	CS2	tCSH		40	_	



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6-3 RESET INPUT TIMING



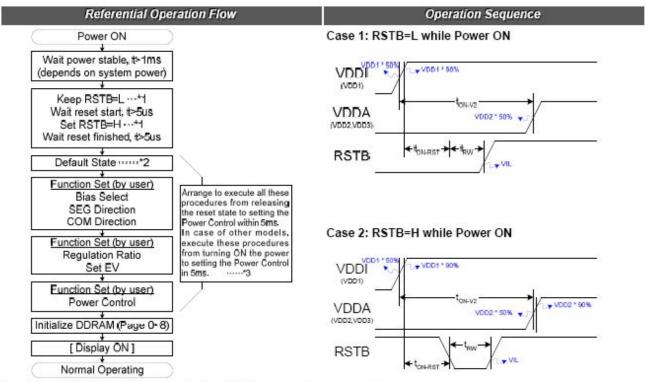
ltem	Cianal	Cymbol	Condition		Rating	Units	
	Signal	Symbol	Symbol	Min.	Тур.	Max.	Units
Reset time		tr		_	_	1.0	us
Reset "L" pulse width	/RES	trw		1.0	_	_	us



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7. POWER ON/OFF SEQUENCE

(1)POWER ON:



Note: The detailed description can be found in the respective sections listed below.

- Please refer to the timing specification of t_{RW} and t_R.
- 2. Refer to Section RESET CIRCUIT.
- The 5ms requirement depends on the characteristics of LCD panel and the external component of the power circuit. It is recommended to check with the real products with external component.
- The detailed instruction functionality is described in Section INSTRUCTION DESCRIPTION;
- 5. Power stable is defined as the time that the later power (VDDI or VDDA) reaches 90% of its rated voltage.

Timing Requirement:

Item	Symbol	Requirement	Note
VDDA power delay	ton-v2	0 ≤ t _{on-v2}	 Applying VDDI and VDDA in any order will not damage IC.
RSTB input time	t _{on-RST}	No Limitation	If RSTB is Low, High or unstable during power ON, a successful hardware reset by RSTB is required after VDDI is stable. RSTB=L can be input at any time after power is stable.
No 15 input anie	VON-RST	No Elimadon	 t_{RW} & t_R should match the timing specification of RSTB. To prevent abnormal display, the recommended timing is: 0 ≤ t_{ON-RST} ≤ 30 ms.

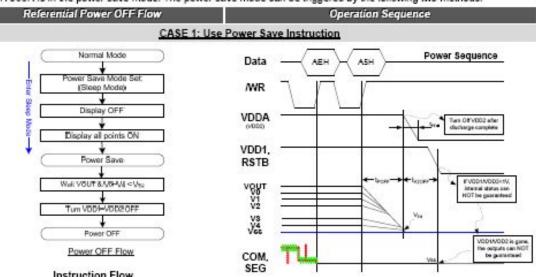
The requirement listed here is to prevent abnormal display on LCD module.



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(2)POWER OFF:

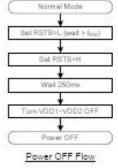
In power save mode, LCD outputs are fixed to VSS and all analog outputs are discharged. The power can be turned OFF after ST7565R is in the power save mode. The power save mode can be triggered by the following two methods.



Instruction Flow

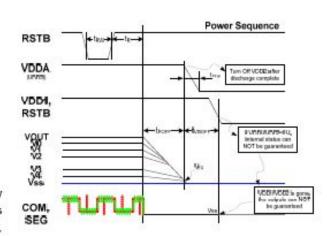
After the built-in power circuits are OFF and completely discharged (the power level of built-in analog circuit is smaller than VTH of LCD panel), the power (VDDI, VDDA) can be removed. V_{TH} is around 0.2V to 1.0V.

CASE 2: Use Hardware Reset Function



Instruction Flow

After the built-in power circuits are OFF and completely discharged (the power level of built-in analog circuit is smaller than V_{TH} of LCD panel), the power (VDDI, VDDA) can be removed. VTH is around 0.2V to 1.0V.



Note:

- t_{NOFF}: Internal Power discharge time. Discharge time for built-in circuit is dependent on user's system design.
- t_{V2OFF}: Period between VDDI and VDDA OFF time. => 0 ms (min).
- 3. It is NOT recommended to turn VDDI OFF before VDDA. Without VDDI, the internal status cannot be guaranteed and internal discharge-process maybe stopped. The un-discharged power maybe flows into COM/SEG output(s) and the liquid crystal in panel maybe polarized.
- 4. IC will NOT be damaged if either VDDI or VDDA is OFF while another is ON.
- 5. The timing is dependent on panel loading and the external capacitor(s).



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8. RECOMMENDED INITIAL CODES

```
void Initial(void)
                                               /* 1/9 bias */
  writec(0xa2);
  writec(0xe2);
                                               /* ADC select , Normal */
  writec(0xa0);
                                               /* Common output reverse */
  writec(0xc8);
                                               /* normal display 1=on */
  writec(0xa6);
  writec(0x2c);
  writec(0x2e);
  writec(0x2f);
                                               /* V/C off, V/R off, V/F on */
  writec(0xf8);
                                               /***4 booster***/
  writec(0x00);
  writec(0x24);
                                               /* internal resistor ratio */
                                               /* electronic volume mode set */
  writec(0x81);
                                               /* electronic volume */
  writec(0x1C);
  writec(0x40);
                                               /* display start first line */
                                              /* display on */
  writec(0xaf);
```



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9.INSTRUCTION TABLE

INSTRUCTION		R/W			С	OMMAI	ND BYT	Έ			DESCRIPTION
INSTRUCTION	A0	(RWR)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
Display ON/OFF	0	0	1	0	1	0	1	1	1	D	D=1, display ON D=0, display OFF
Set Start Line	0	0	0	1	S5	S4	S3	S2	S1	S0	Set display start line
Set Page Address	0	0	1	0	1	1	Y3	Y2	Y1	Y0	Set page address
Set Column Address	0	0	0	0	0	1	X7	X6	X5	X4	Set column address (MSB)
Set Column Address	0	0	0	0	0	0	Х3	X2	X1	X0	Set column address (LSB)
Read Status	0	1	BUSY	MX	D	RST	0	0	0	0	Read IC Status
Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write display data to RAM
Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read display data from RAM
SEG Direction	0	0	1	0	1	0	0	0	0	MX	Set scan direction of SEG MX=1, reverse direction MX=0, normal direction
Inverse Display	0	0	1	0	1	0	0	1	1	INV	INV =1, inverse display INV =0, normal display
All Pixel ON	0	0	1	0	1	0	0	1	0	AP	AP=1, set all pixel ON AP=0, normal display
Bias Select	0	0	1	0	1	0	0	0	1	BS	Select bias setting 0=1/9; 1=1/7 (at 1/65 duty)
Read-modify-Write	0	0	1	1.	1	0	0	0	0	0	Column address increment: Read:+0 , Write:+1
END	0	0	1	1	1	0	1	1	1	0	Exit Read-modify-Write mode
RESET	0	0	1	1	1	0	0	0	1	0	Software reset
COM Direction	0	0	1	1	0	0	MY	1	-	-	Set output direction of COM MY=1, reverse direction MY=0, normal direction
Power Control	0	0	0	0	1	0	1	VB	VR	VF	Control built-in power circuit ON/OFF
Regulation Ratio	0	0	0	0	1	0	0	RR2	RR1	RR0	Select regulation resistor rati
Set EV	0	0	1	0	0	0	0	0	0	1	Double command!! Set
Set Ev	0	0	0	0	EV5	EV4	EV3	EV2	EV1	EV0	electronic volume (EV) level
Power Save Mode Set	0	0	1	0	1	0	1	1	0	MD	MD=0, sleep mode
Tower Save Mode Set	0	0	0	0	0	0	0	0	0	0	MD=1, normal
Power Save	0	0			Co	mpound	Comm	and		772 755	Display OFF + All Pixel ON
Set Booster	0	0	1	1	1	1	1	0	0	0	Double command!! Set booster level: BL[1:0]=(0,0), x2, x3, x4
Oct Doostel	0	0	0	0	0	0	0	0	BL1	BL0	BL[1:0]=(0,0), X2, X3, X4 BL[1:0]=(0,1), X5 BL[1:0]=(1,1), X6
NOP	0	0	1	1	1	0	0	0	1	1	No operation
Test	0	0	1	1	1	1	-	-	5	-	Do NOT use. Reserved for testing.

Note: Symbol "-" means this bit can be "H" or "L".



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10.ELECTRICAL CHARACTERISTICS

10-1 Absolute maximum ratings

ITEM	CVMDOI	STA	IINIT		
ITEM	SYMBOL	MIN	TYP	MAX	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD	-0.3		+3.6	V
LCD POWER SUPPLY VOLTAGE	VIN	-0.3		13.5	V
OPERATING TEMPERATURE	T _{OP}	-20		70	$^{\circ}\!\mathbb{C}$
STORAGE TEMPERATURE	T _{STG}	-30		80	$^{\circ}\mathbb{C}$

10-2 Electrical characteristics

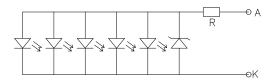
ITEM	CVMDOI	CONDITIONS		DARD V	ALUE	INUT
HEM	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD		3.2	3.3	3.4	V
SUPPLY VOLTAGE FOR LCD	V0-VSS		8.1	8.3	8.5	V
INPUT VOLTAGE "H" LEVEL	VIH		0.8VDD	-	VDD	V
INPUT VOLTAGE "L" LEVEL	VIL		VSS	-	0.2VDD	V
OUTPUT VOLTAGE "H" LEVEL	VOH	Ta= 25 °C	0.8VDD	-	VDD	V
OUTPUT VOLTAGE "L" LEVEL	VOL		VSS	-	0.2VDD	V
CURRENT CONSUMPTION (CHECKER)	IDD		-	0.5	1.0	mA
POWER CONSUMPTION (CHECKER)	PC		-	1.65	3.3	mW



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D D O O .	0. 20.	110.			

11. LED BACKLIGHT

11-1 LED CIRCUIT:



11-2.ABSOLUTE MAXIMUN RATING

PARAMETER	SYMBOL	SPECIFICATIONS	UNIT
POWER DISSIPATION	PD	400	mW
FORWARD CURRENT	Ifm	100	mA
PEAK FORWARD CURRENT	Ifp	300	mA
REVERSE VOLTAGE	Vr	5	V
OPERATION TEMPERATURE	TOPR	-20℃~+70℃	$^{\circ}$
STORAGE TEMPERATURE	TSTG	-30°C∼+80°C	°C

11-3. ELECTRICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYMBOL	LIGHT	CONDITIONS	STANI	DARD V	ALUE	UNIT
		SOURCE		MIN	TYP	MAX	
FORWARD CURRENT	If		Vak=4.0V	-	75	100	mA
REVERSE CURRENT	IR	White	Vr= 5V/LED	-	-	10	uA
BL BRIGHTNESS	Lv		Vak=4.0V	800	1000	-	cd/m ²
CIE Color	X		Vak=4.0V	0.24	0.27	0.30	-
Coordinate(without LCD)	Y		vak=4.0V	0.24	0.27	0.30	-
LUMINOUS UNIFORMITY	Δ		Vak=4.0V	75%	-	-	%.

Note: Uniformity Δ =(minmum LV/maximum LV)*100%.

For operation above 25°C, The Ifm、 Ifp & PD must be derated ,the Current derating is -0.36mA/°C for Dc drive and-0.9mA/°C for pulsr drive,the power dissipation is -1.08 mW/°C, The product working current must not more than the 60 % of the Ifp according to the working temperature.

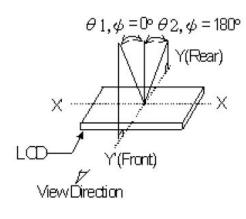
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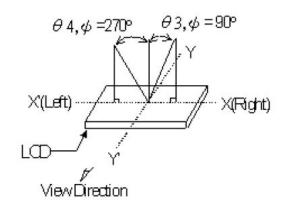
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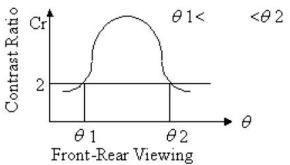
12. OPTICAL CHARACTERISTICS

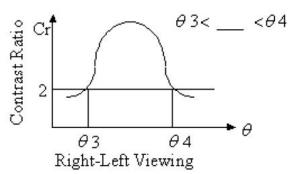
Itei	n	Symbol	Temp.	Condition	Min.	Тур.	Max.	Unit.	Note
Rise time Response	D.		-20℃		-	2100	2500		
		tr	25℃		-	120	250		
	time		60℃	θ=0°	-	38	45	mS 40	
Time	fall		-20℃	φ=0°	-	4400	5300		-
	time	tf	25℃		-	200	240		
	tillic		60°C		-	65	80		
				Ф=0°	-	30	-		
Viewing	Angle	θ	25℃	Ф=90°	-	30	-	daa	
		Ө	Cr≥2	Ф=180°	-	30	-	deg.	_
				Ф=270°	-	40	-		
Contrast	Ratio	Cr	25℃	θ=φ=0°	3	5	-	-	_

(1) DEFINITION OF VIEWING ANGLE





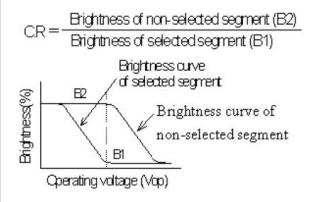




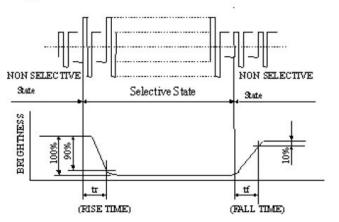


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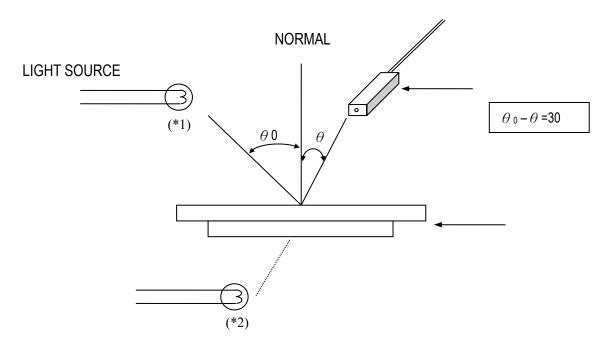
(2) DEFINITION OF CONTRAST



(3) DEFINITION OF RESPONSE



(4) MEASURING INSTRUMENTS FOR ELECTRO-OPTICAL CHARACTERISTICS



- *1.Light source position for measuring the reflective type of LCD panel
- *2.Light source position for measuring the transflective / transmissive types of LCD panel



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13. ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	CONDITIONS	CRITERION
OPERATING TEMPERATURE	TOPR	-20℃ ~+70℃	NO DEFECT IN DISPLAYING AND
OPERATING TEMPERATURE	TOPK	-20 C ∼+70 C	OPERATIONAL FUNCTION
STORAGE TEMPERATURE	TSTG	-30℃ ~+80℃	NO DEFECT IN DISPLAYING AND
STORAGE TEMPERATURE	1816	-30 C ~+80 C	OPERATIONAL FUNCTION
HUMIDITY	_	See Note	WITHOUT CONDENSATION

Note: Test condition:

- 1) Temperature and humidity: if no specification, temperature set at $25+/-2^{\circ}C$, and humidity set at 60+/-5% RH.
 - 2)Operating state:all the tests to which the samples subject should be in operating condition.

14. RELIABILITY TEST

ITEM	CONDITIONS	CRITERION
Operating	HIGH TEMPERTURE 70℃ 120HRS	No defect in displaying and operational
Temperature	LOW TEMPERTURE -20°C 120HRS	function
Storage	HIGH TEMPERTURE +80℃ 120HRS	No defect in displaying and operational
Tempereature	LOW TEMPERTURE -30°C 120HRS	function
High Humidity &	40℃* 90%RH 120HRS	No defect in displaying and operational
high Temp	40 C 90/6KH 120HKS	function
	• Operating Time: 30 minutes exposure for	
Vibration	each direction (X,Y,Z)	No defect in displaying and operational
Violation	• Sweep Frequency: 10~55Hz (1 min)	function
	Amplitude: 1.5mm	
Thermal Shock	$-20^{\circ}\text{C}(30\text{mins}) \leftarrow \rightarrow +70^{\circ}\text{C}(30\text{mins}) 50 \text{ cycles}$	No defect in displaying and operational
Thermal Shock	-20 C(Johnnis) X 7 + 70 C(Johnnis) 30 Cycles	function

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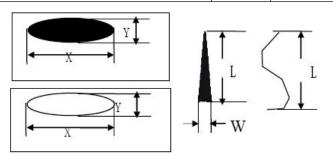
15. THE STANDARD OF INSPECTION

15-1 SAMPLING PLAN

Unless there is other agreement, sampling plan for incoming inspection should follow GB2828-2003.

- 15-1-1 Lot size: Quantity per shipment as one lot (different model as different lot .)
- 15-1-2 Sampling type: Normal inspection, single sampling.
 - 15-1-3 Sampling level: Level II.
 - 15-1-4 Acceptable Quality Level

Major defect: AQL=0.40 Minor defect: AQL=0.65 Total defect : AQL=0.65



15-2 PANEL INSPECTION CONDITION

- 15-2-1 Environment:Room Temperature: 25 ± 5 °C. Humidity: 55 ± 5% RH.Illumination:800~1200Lux.
- 15-2-2 Inspection Distance: 25 ± 5 cm from the inspector to the module.
- 15-2-3 Inspection Angle: The vision of inspector should be perpendicular to the surface of the module.

16-3 MODULE INSPECTION STANDARDS

16-3-1 Defect definition

MAJOR:display or functional defects, serious deviation from the specifications, customers can not work properly; Severe skin defects, serious deviation from the specifications, the client does not work properly.

MINOR: slightly deviate from the specifications, does not affect the product function, but the appearance of an impact on product

Note: The following standard if no entities are specified, with mm meter.

15-3-2 Product area and size code definition

A area: said display active area(characters display)

B area: says visual area (except A area)

C area: the unvisual areas.

T: it says the thickness of the single glass

L: said glass pin lengths

K: said product length

X :said glass long side direction or glass edge direction along the length of the gap

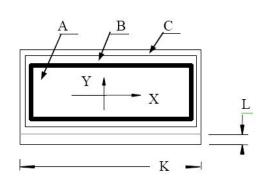
Y :said glass short side direction or gap with glass edge along the vertical length

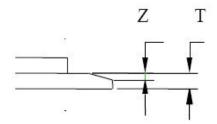
Z: the thickness of crack or gap

15-3-2 Point, line definition

point: $\Phi = (X + Y) / 2$

The length of the X says point length; Y says point width Line:L says the length of the line; W says line width







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DOC.	spectic Item Dim	SPEC on items ar	Criterion Dimension o Criterion Dimension o Criterion Criterion Dimension o Criterion Criterion Dimension o Criterion Criterion Dimension o Criterion Z Z Z Z Z Z Z Z Z Z Z Z Z	n for appe ut of the serack	earance(power specification	X ≥ K/8 X ≥ K/8 X ≥ K/8	Y Not over A area Y Not over A area Y V V V V V V V V V	Z	check	AQL 1.0
3		ek dot \ te dot	Transfer pos Y X: long diam	X 	k: $\leq L/5$ D D<0.2 0.2 \leq D<0 0.3 \leq D \leq 0 D>0.5	3 2	cceptable of defect/B Area o check	C A	check	2.50



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4	Line	e defect	1	L W T L Sth W: Wi		hidth $ \begin{array}{c} W \leqslant 0.02 \\ W \leqslant 0.05 \\ W \leqslant 0.05 \\ \end{array} $ $ \begin{array}{c} W \leqslant 0.05 \\ \end{array} $ $ \begin{array}{c} W > 0.05 \\ \end{array} $ es. Spot): A		Acceptable of A/B Area No check 2 2 As round type ng to the lim	No o	check	2.50
5	Pola Bub	ırizer ble	Y	X	D D≤0.2 0.2≤D 0.5≤D D>1.0	≤0.5 ≤1.0	Acce table A/B A No cl 3 2	of defect Area	C Area		2.50
6	Exte of pa	ernal print anel				e as segment a standard wi					2.50
7	Silic	con glue	The are	ea of paintin	g silicon g	lue must cov	er the IT	O circuit.			2.50
8	Defe PCB	ect of	are unr	eceivable fo	or PCB.	resking off ci					2.50
9	SMT	Γorgan	deflexion of component ≤ 1/3 width of component Trying to keep dot of soldering tin orbicular Damage \times break \times wrong assembly and unseal are unreceivable for component.					2.50			
10	Stee	l Frame	Break and distortion are unreceivable for frame. If there is one pick which can not lead to cast or hole of painting, we allow					2.50			
15-3-4	4Inspect	tion items a	and speci	fication for	display de	fect(power or	n)				
1	Elec Defe	etrical		Segm	nent missin nent s display	Not allow Not allow Not allow	7		-		1.0



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2	Pin hol	e	1. Pi	n hole	¥ ₹B	width W<0.4 W≥0.4 * D=(A+B)/2	Acceptable of $D \le 0.2 \& D \le 0.25 \& D$ $D \le 0.1 \text{ accept}$	≤1/2W D≤1/3W	2.50
3	Display pattern		W: De	esign dimensi	on C	Width W<0.4 W≥0.4 D: discrepant di	Acceptable o C , D , $G \le C$, D , $G \le C$ The mension $G = E-F $	1/2W	1.0
4	Black/v	white	X: lor Y: sho	ng diameter ot diameter erage diamete	er D	D $D < 0.1$ $0.1 \le D < 0.2$ $0.2 \le D \le 0.25$ $D > 0.25$ $= (X+Y)/2$	No check	Y C Area	2.50
5	Line de	efect		I W	Length 不计 L≤3 L≤2.5	Width $ \begin{array}{c} W \leqslant 0.02 \\ W \leqslant 0.03 \\ 0.03 < W \leqslant 0.0 \\ W > 0.05 \end{array} $ ength W: width	No check	C Area	2.50

16. USING LCD MODULES

16-1 LIQUID CRYSTAL DISPLAY MODULES

- LCD is composed of glass and polarizer. Pay attention to the following items when handling.
- (1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.



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- (2) Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (glass, tweezers, etc.).
 - (3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
 - (4) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, wipe gently with absorbent cotton or other soft material like chamois soaked in Isopropyl alcohol or Ethyl alcohol. Do not scrub hard to avoid damaging the display surface.
 - (5) Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
 - (6) Avoid contacting oil and fats.
 - (7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers.

 After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
 - (8) Do not put or attach anything on the display area to avoid leaving marks on.
 - (9) Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
 - (10) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
 - (11) As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

16-2 PRECAUTION FOR HANDING LCD MODULES

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- (1) Do not alter, modify or change the the shape of the tab on the metal frame.
- (2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- (3) Do not damage or modify the pattern writing on the printed circuit board.
- (4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- (5) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- (6) Do not drop, bend or twist LCM. In particular, do not forcibly pull or bend the IYO cable or the backlight cable.
- (7) In order to avoid the cracking of the FPC, you should to pay attention to the area of FPC where the FPC was bent .the edge of coverlay; the area of surface of Ni-Au plating, the area of soldering land, the area of through hole.

16-3 ELECTRO-STATIC DISCHARGE CONTROL

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

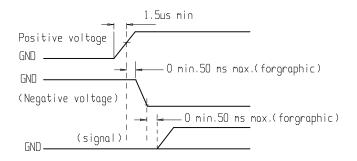


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- (1) Make certain that you are grounded when handing LCM. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules. Exposed area of the printed circuit board. Terminal electrode sections.
- (2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- (3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- (4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- (5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
 - (6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

16-4 PRECAUTIONS FOR OPERATION

- (1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
 - (2) Driving the LCD in the voltage above the limit shortens its life.
 - (3) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
 - (4) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
 - (5) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
 - (6) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40 C, 50% RH.
 - (7) When turning the power on, input each signal after the positive/negative voltage becomes stable.





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16-5 STORAGE

When storing LCDs as spares for some years, the following precaution are necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0 C and 35 C.
 - 3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
 - (4) Environmental conditions:
 - Do not leave them for more than 180hrs. at 70 C.
 - Should not be left for more than 48hrs, at -20 C.

16-6 SAFETY

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leakes out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

14-7 LIMITED WARRANTY

Unless agreed between SUCCESS and customer, SUCCESS will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with SUCCESS LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to SUCCESS within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of SUCCESS limited to repair and/or replacement on the terms set forth above. SUCCESS will not be responsible for any subsequent or consequential events.

16-8 RETURN LCM UNDER WARRANTY

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- Circuit modified in any way, including addition of components.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB's eyelet, conductors and terminals.